





Next Data Sheet 次のデータシート Data Sheet No. PD-6.057D

IR51H737

SELF-OSCILLATING HALF-BRIDGE

Features

- Output Power MOSFETs in half-bridge configuration 300V Rated Breakdown Voltage
- High side gate drive designed for bootstrap operation
- Accurate timing control for both Power MOSFETs Matched delay to get 50% duty cycle Matched deadtime of 1.2us
- Internal oscillator with programmable frequency

$$f = \frac{1}{1.4 \times (RT + 75\Omega) \times CT}$$

- Zener clamped Vcc for offline operation
- Half-bridge output is out of phase with R_T

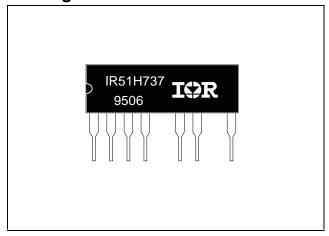
Description

The IR51H737 is a high voltage, high speed, selfoscillating half-bridge. Proprietary HVIC and latch immune CMOS technologies, along with the HEXFET® power MOSFET technology, enable ruggedized single package construction. The front-end features a programmable oscillator which functions similar to the CMOS 555 timer. The supply to the control circuit has a zener clamp to simplify offline operation. The output features two HEXFETs in a half-bridge configuration with an internally set deadtime designed for minimum cross-conduction in the half-bridge. Propagation delays for the high and low side power MOSFETs are matched to simplify use in 50% duty cycle applications. The device can operate up to 300 volts.

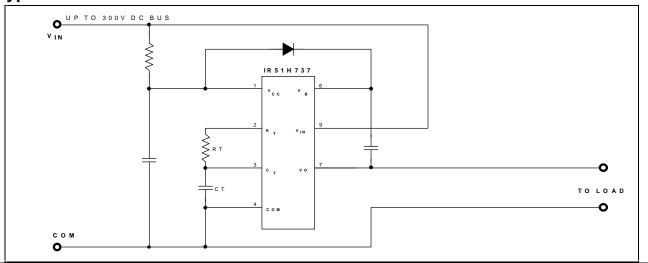
Product Summary

| V _{IN} (max) | 300V |
|-------------------------------|--------------|
| Duty Cycle | 50% |
| Deadtime | 1.2µs |
| R _{DS(on)} | 0.75Ω |
| $P_D (T_A = 25 {}^{\circ}C)$ | 2.0W |

Package



Typical Connection















Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

| | Parameter | | | |
|-----------------|--|------|-----------------------|-------|
| Symbol | Definition | Min. | Max. | Units |
| V _{IN} | High Voltage Supply | -0.3 | 300 | |
| V_{B} | High Side Floating Supply Absolute Voltage | -0.3 | 325 | |
| VO | Half-Bridge Output Voltage | -0.3 | V _{IN} + 0.3 | V |
| V_{RT} | R _T Voltage | -0.3 | $V_{CC} + 0.3$ | |
| V _{CT} | C _T Voltage | -0.3 | V _{CC} + 0.3 | |
| Icc | Supply Current (Note 1) | | 25 | mΑ |
| I _{RT} | R _T Output Current | -5 | 5 | |
| dv/dt | Peak Diode Recovery dv/dt | | 3.4 | V/ns |
| P_D | Package Power Dissipation @ T _A ≤ +25°C | | 2.00 | W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | | 60 | °C/W |
| TJ | Junction Temperature | -55 | 150 | |
| Ts | Storage Temperature | -55 | 150 | ٥C |
| T_L | Lead Temperature (Soldering, 10 seconds) | | 300 | |

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions.

| | Parameter | | | |
|----------------|--|---------|-------------------------|-------|
| Symbol | Definition | Min. | Max. | Units |
| V_B | High Side Floating Supply Absolute Voltage | VO + 10 | VO + V _{CLAMP} | |
| V_{IN} | High Voltage Supply | | 300 | V |
| VO | Half-Bridge Output Voltage | -5 | 300 | |
| I _D | Continuous Drain Current (T _A = 25°C) | | 1.3 | Α |
| | $(T_A = 85^{\circ}C)$ | | 0.8 | |
| Icc | Supply Current (Note 1) | | 5 | mA |
| T _A | Ambient Temperature | -40 | 125 | °C |

Note 1: Because of the IR51H737's application specificity toward off-line supply systems, this IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6V. Therefore, the IC supply voltage is normally derived by current feeding the V_{CC} lead (typically by means of a high value resistor connected between the chip V_{CC} and the rectified line voltage and a local decoupling capacitor from V_{CC} to COM) and allowing the internal zener clamp circuit to determine the nominal supply voltage. Therefore, this circuit should not be driven by a DC, low impedance power source of greater than V_{CLAMP}.











Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC}, V_B) = 12V unless otherwise specified.

| | Parameter | | $T_A = 25^{\circ}C$ | | | |
|-----------------|---|------|---------------------|------|-------|----------------------------|
| Symbol | Definition | Min. | Тур. | Max. | Units | Test Conditions |
| t _{rr} | Reverse Recovery Time (MOSFET Body Diode) | | 320 | | ns | I _F = 1.3 A |
| Q _{rr} | Reverse Recovery Charge (MOSFET Body Diode) | | 1.5 | | μC | di/dt = 100A/µs |
| DT | Deadtime, LS Turn-Off to HS Turn-On & HS Turn-Off to LS Turn-On | | 1.2 | | μs | |
| D | R _T Duty Cycle | | 50 | | % | $f_{OSC} = 20 \text{ kHz}$ |

Static Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{B}) = 12V unless otherwise specified.

| | Parameter | | $T_A = 25^{\circ}C$ | | | | |
|---------------------|--|-------|---------------------------|-------|-------|-----------------|---|
| Symbol | Definition | Mir | Min. Typ. Max. Unit | | Units | Test Conditions | |
| Supply | Characteristics | | | | | | |
| V _{CCUV+} | V _{CC} Supply Undervoltage Positive Going Threshold | | | 8.4 | - | V | |
| V _{CCUV} - | V _{CC} Supply Undervoltage Negative Going Threshold | | | 8.0 | 1 | | |
| Iqcc | Quiescent V _{CC} Supply Current | | | 300 | | μA | |
| V_{CLAMP} | V _{CC} Zener Shunt Clamp Voltage | | | 15.6 | | V | $I_{CC} = 5 \text{ mA}$ |
| Floating | Supply Characteristics | - | | | | | |
| I _{QBS} | Quiescent V _{BS} Supply Current | | | 30 | | μA | |
| los | Offset Supply Leakage Current ! | 50 | | V | | | $_{B} = V_{IN} = 300V$ |
| Oscillate | or I/O Characteristics | | | | | | |
| fosc | Oscillator Frequency | | | 20 | | kHz | $R_T = 35.7 \text{ k}\Omega,$ $C_T = 1 \text{ nF}$ |
| | | | | 100 | | | $R_T = 7.04 \text{ k}\Omega,$ $C_T = 1 \text{ nF}$ |
| I _{CT} | C _T Input Current | | | 0.001 | 1.0 | μA | |
| Vctuv | C _T Undervoltage Lockout | 100 - | | | 2.5 | V < V | cc < Vccuv+ |
| V_{RT+} | R _T High Level Output Voltage, V _{CC} - R _T | | | 20 | | | $I_{RT} = -100 \mu A$ |
| | | | | 200 | | mV | $I_{RT} = -1 \text{ mA}$ |
| V_{RT} | R _T Low Level Output Voltage | | | 20 | | | $I_{RT} = 100 \mu A$ |
| | | | | 200 | | | $I_{RT} = 1 \text{ mA}$ |
| V_{RTUV} | R _T Undervoltage Lockout, V _{CC} - R _T | | | 100 | | | $2.5V < V_{CC} < V_{CCUV+}$ |
| V _{CT} + | 2/3 V _{CC} Threshold | | | 8.0 | | V | |
| V _{CT} - | 1/3 V _{CC} Threshold | | | 4.0 | | | |
| Output (| Characteristics | | | | | | |
| R _{DS(on)} | Static Drain-to-Source On-Resistance | | | 0.75 | | Ω | $I_{D} = 800 \text{mA}$ |
| V_{SD} | Diode Forward Voltage 0.8 - | | | | | V | $T_i = 150 {}^{\circ}\text{C}$ |



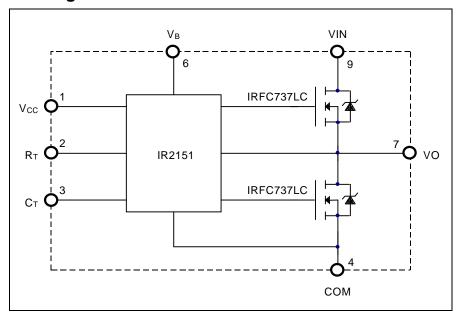








Functional Block Diagram



Lead Definitions

| Lead | | | | |
|----------------|--|--|--|--|
| Symbol | Description | | | |
| Vcc | Logic and internal gate drive supply voltage. An internal zener clamp diode at 15.6 V nominal is included to allow the Vcc to be current fed directly from V_{IN} typically by means of a high value resistor. | | | |
| R _T | Oscillator timing resistor input; a resistor is connected from R_T to C_T . R_T is out of phase with the half-bridge output (VO). | | | |
| Ст | Oscillator timing capacitor output; a capacitor is connected from C _T to COM in order to program the oscillator frequency according to the following equation: | | | |
| | $f = \frac{1}{1.4 \times (RT + 75\Omega) \times CT}$ | | | |
| | where 75 Ω is the effective impedance of the R _T output stage. | | | |
| V _B | High side gate drive floating supply. For bootstrap operation a high voltage fast recovery diode is needed to feed from V_{CC} to V_B . | | | |
| V_{IN} | High voltage supply. | | | |
| VO | Half-bridge output. | | | |
| COM | Logic and low side of half-bridge return. | | | |



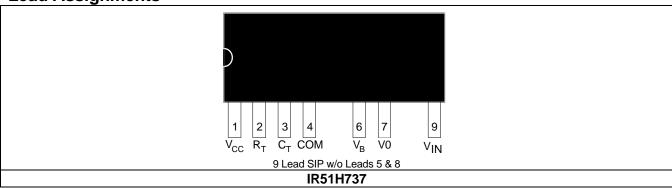








Lead Assignments



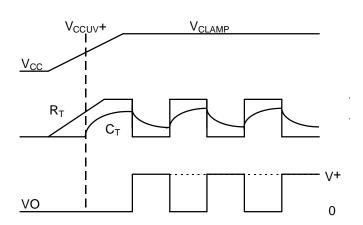


Figure 1. Input/Output Timing Diagram

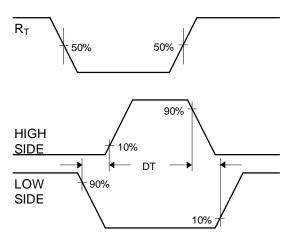


Figure 2. Deadtime Waveform Definitions





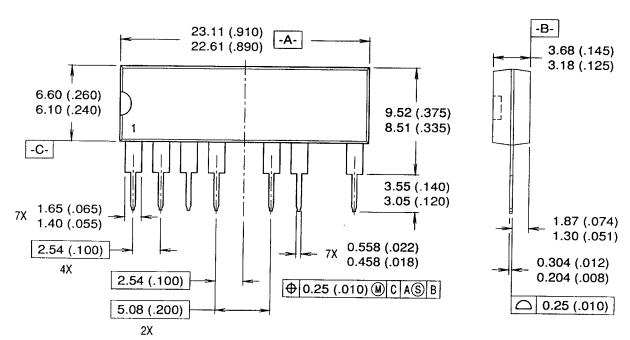
IR51H737











NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).

Package Outline



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EUROPEAN HEADQUARTERS: Hurst Green, Oxted, Surrey RH8 9BB, UK Tel: ++ 44 1883 732020
IR CANADA: 7321 Victoria Park Ave., Suite 201, Markham, Ontario L3R 2Z8, Tel: (905) 475 1897
IR GERMANY: Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590
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